PRODUCT / PROCESS CHANGE INFORMATION

| 1. PCI basic data | | |
|----------------------|--|--|
| 1.1 Company | | STMicroelectronics International N.V |
| 1.2 PCI No. | | MDG/20/11881 |
| 1.3 Title of PCI | | New leader/trailer for micromodules |
| 1.4 Product Category | | Advantis, Prisma, ST33, ST31 STPay, CD21 |
| 1.5 Issue date | | 2020-07-22 |

| 2. PCI Team | | |
|---------------------------|--------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | ROBERTSON HEATHER | |
| 2.1.2 Phone | +1 8475853058 | |
| 2.1.3 Email | heather.robertson@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Marie-France FLORENTIN | |
| 2.1.2 Marketing Manager | Bruno BATUT | |
| 2.1.3 Quality Manager | Mickael DENAIS-ALLICHON | |

| 3. Change | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, etc | ST Bouskoura |

| 4. Description of change | | | |
|---|--|--|--|
| Old New | | | |
| 4.1 Description | chips molded modules is now consolidated | New supplier : Tongxi New Material : PET (color : white) New Length : 1.2m max. target | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | | | |

| 5. Reason / motivation for change | | |
|--|---------------------|--|
| 5.1 Motivation Brittle effect can be seen on current leader/trailer tape. This will be solved with ne Manufacturability will be improved | | |
| 5.2 Customer Benefit | QUALITY IMPROVEMENT | |

| 6. Marking of parts / traceability of change | |
|--|----------------------|
| 6.1 Description | not seen on product. |

| 7. Timing / schedule | | |
|-------------------------------------|----------------|--|
| 7.1 Date of qualification results | 2019-04-05 | |
| 7.2 Intended start of delivery | 2019-12-20 | |
| 7.3 Qualification sample available? | Not Applicable | |

| 8. Qualification / Validation | | | |
|---|-------------|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

9. Attachments (additional documentations)

11881 Public product.pdf 11881 PCI deployment of new trailer tape-1.pdf

 10. Affected parts

 10. 1 Current
 10.2 New (if applicable)

 10.1.1 Customer Part No
 10.1.2 Supplier Part No

 STM32HSM-V1AE
 STM32HSM-V1BE



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : New leader/trailer for micromodules

PCI Reference : MDG/20/11881

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| STM32HSM-V1BE | STM32HSM-V1ML | STM32HSM-V1AE |
|---------------|---------------|---------------|
| STM32HSM-V1XL | | |

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